

Quarterly Reliability Monitoring Results

Quarters: Q1/2022 to Q4/2023

Based on structural similarity

Supplier		User Part Number						
Nexperia B.V. Name of Laboratory Assembly reliability labs		PIMN31PA Part Description						
		MCD package						
		Test		Test Conditions	Duration	# Lots	# Quantity	# Rejects
	TEST							
	Pre- and Post-Stress							
# 1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below		
		JESD22-A113 Bake Tamb = 125 °C	24 hours					
	PC	Soak Tamb = 85 °C, RH = 85%	168 hours					
# 2	Preconditioning	Reflow soldering	3 cycles	464	20960	0		
		MIL-STD-750-1						
	HTRB	M1039 Method A						
# F	High Temperature Reverse Bias	Tj = Tjmax, Vr = 100% of max. datasheet reverse voltage	1000 haven	415	10000	0		
# 5	Dias	Teverse voltage	1000 hours	415	18680	0		
	тс	JESD22-A104						
# 7	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	500 cycles	116	5240	0		
	UHAST	JESD22-A118						
# 8 or	Unbiased HAST	Tamb = 130 °C, RH = 85 %	— 96 hours	116	5240	0		
		JESD22-A102						
	AC	Tamb = 121 °C, RH = 100 %						
# 8a	Autoclave	Pressure = 205 kPa (29.7 psia)						
	H3TRB	JESD22-A101						
	High Humidity High	Tamb = $85 ^{\circ}$ C, RH = 85% , VR = 80% of						
# 9	Temperature Reverse Bias		1000 hours	116	5240	0		
# J		MIL-STD-750 Method 1037	1000 110013	110	5240	0		
	IOL	ton = toff, devices powered to insure ΔTj =						
# 10	Intermittent Operating Life	100 °C	333 hours	116	5240	0		
	DCU							
# 20	RSH Resistance to Solder Heat	JESD22-A111 260 °C ± 5 °C	10 -					
# 20			10 s	n.a.	n.a.	n.a.		
	SD Solderability	J-STD-002		86	2580	0		

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test # 5) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia DHAM	Small Signal Bipolar Transistor	18680	0	0,23	4,40E+09

© 2024 Nexperia B.V.

All information hereunder is per Nexperia's best knowledge. This document does not provide for any representation or warranty express or implied by Nexperia. In case Nexperia has tested the product, this documentation reflects the outcome of the analysis of the actually tested parts only.

nexperia.com